

Electronic Acknowledgement Receipt

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Title of Invention:	Polycrystalline Silicon Layer With Nano-grain Structure and Method of Manufacture
First Named Inventor:	Ashima B. Chakravarti
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Transmittal letter	FIS920030317TRANSM.pdf	53961	no	1

Warnings:					
Information:					
2	Supplemental Response or Supplemental Amendment	FIS920030317Amend-.pdf	133708	no	5
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